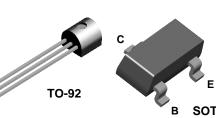


## **NPN General Purpose Amplifier**

This device is designed for low noise, high gain, general purpose amplifier applications at collector currents from 1µA to 50 mA.



SOT-23 Mark: 3M

#### **Absolute Maximum Ratings\*** TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	50	V
V <sub>CBO</sub>	Collector-Base Voltage	50	V
V <sub>EBO</sub>	Emitter-Base Voltage	4.5	V
I <sub>C</sub>	Collector Current - Continuous	100	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

#### **Thermal Characteristics** TA = 25°C unless otherwise noted

Symbol	Characteristic	Max.		Units	
Symbol		2N5210	MMBT5210	Onits	
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	m₩ m₩/°C	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case	83.3		°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W	

# NPN General Purpose Amplifier (continued)

Electrical Characteristics TA = 25°C unless otherwise noted					
Symbol	Parameter	Test Conditions	Min	Max	Units

## OFF CHARACTERISTICS

V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage	$I_{\rm C} = 1.0$ mA, $I_{\rm B} = 0$	50		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_{\rm C} = 0.1 \text{ mA}, I_{\rm E} = 0$	50		V
I <sub>CBO</sub>	Collector Cutoff Current	$V_{CB} = 35 \text{ V}, \text{ I}_{E} = 0$		50	nA
I <sub>EBO</sub>	Emitter Cutoff Current	$V_{EB} = 3.0 \text{ V}, I_{C} = 0$		50	nA

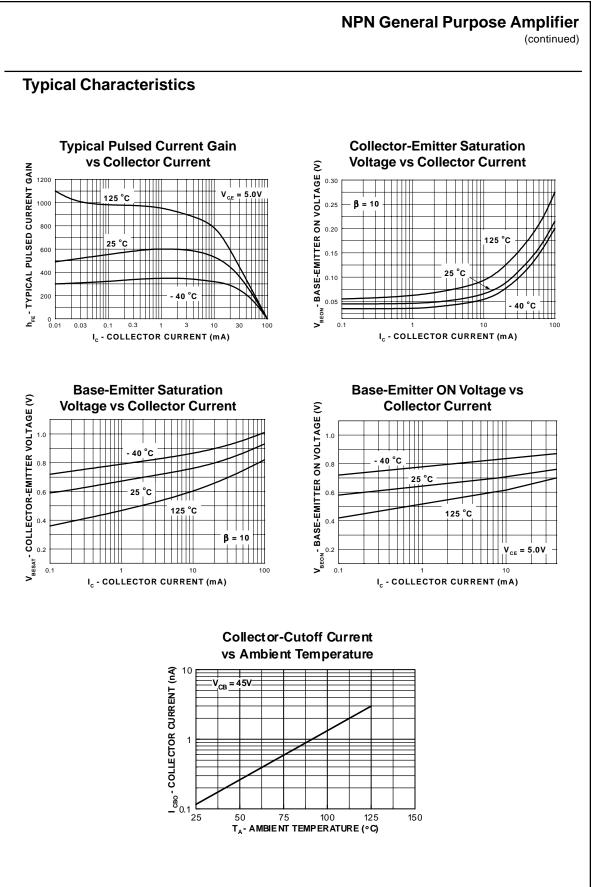
## **ON CHARACTERISTICS**

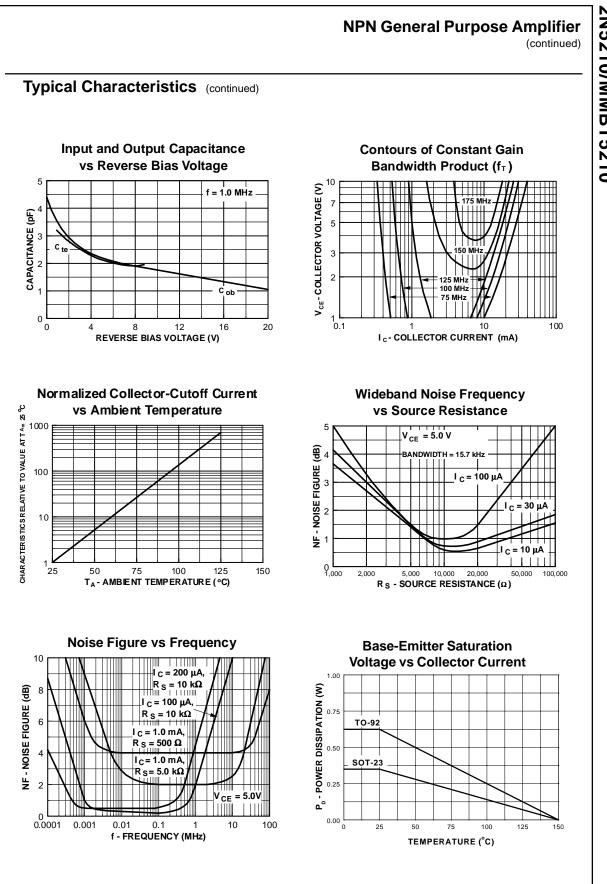
h <sub>FE</sub>	DC Current Gain	$I_{C} = 100 \ \mu\text{A}, \ V_{CE} = 5.0 \ V$ $I_{C} = 1.0 \ \text{mA}, \ V_{CE} = 5.0 \ V$	200 250	600	
		$I_{C} = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}^{*}$	250		
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	$I_{\rm C} = 10$ mA, $I_{\rm B} = 1.0$ mA		0.7	V
V <sub>BE(on)</sub>	Base-Emitter On Voltage	$I_{\rm C}$ = 1.0 mA, $V_{\rm CE}$ = 5.0 V		0.85	V

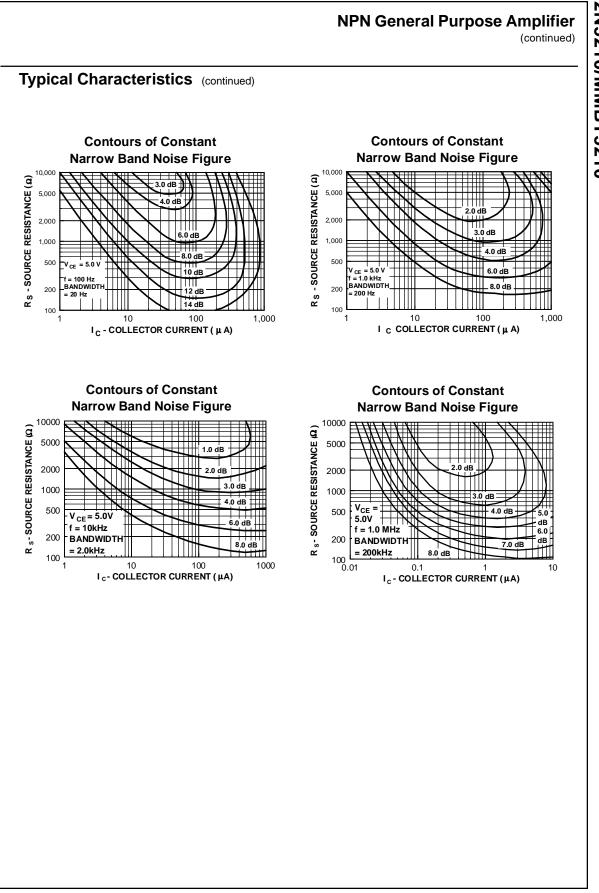
## SMALL SIGNAL CHARACTERISTICS

f <sub>T</sub>	Current Gain - Bandwidth Product	$I_{C} = 500 \ \mu A, V_{CE} = 5.0 \ V,$ f = 20 MHz	30		MHz
C <sub>cb</sub>	Collector-Base Capacitance	$V_{CB} = 5.0 \text{ V}, I_E = 0, f = 100 \text{ kHz}$		4.0	pF
h <sub>fe</sub>	Small-Signal Current Gain	$I_{c} = 1.0 \text{ mA}, V_{CE} = 5.0 \text{ V},$ f = 1.0 kHz	250	900	
NF	Noise Figure	$I_{c} = 20 \ \mu\text{A}, V_{CE} = 5.0 \ \text{V},$ $R_{s} = 22 \ \text{k}\Omega, \text{f} = 10 \ \text{Hz} \text{ to } 15.7 \ \text{kHz}$		2.0	dB
		$I_{c} = 20 \ \mu A$ , $V_{CE} = 5.0 \ V$ , $R_{s} = 10 \ k\Omega$ , $f = 1.0 \ kHz$		3.0	dB

\*Pulse Test: Pulse Width  $\leq$  300  $\mu s,$  Duty Cycle  $\leq$  2.0%

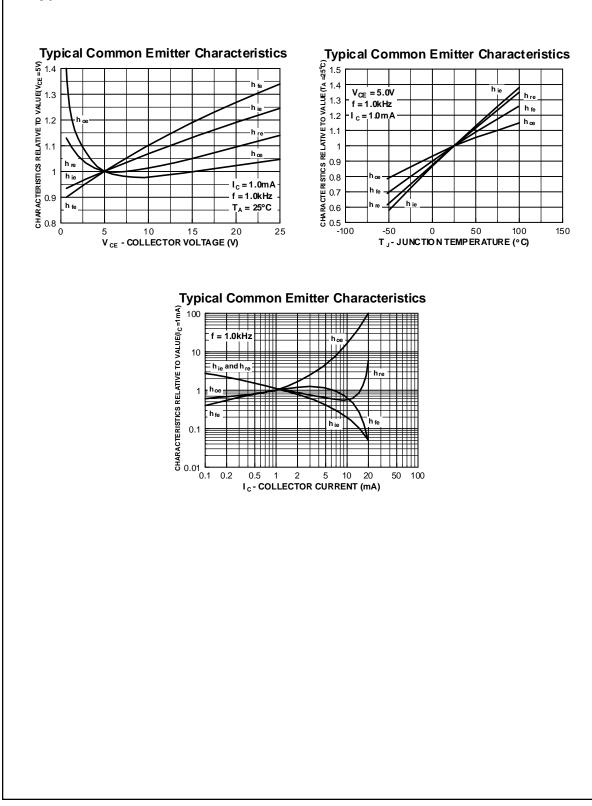






## NPN General Purpose Amplifier (continued)

## Typical Common Emitter Characteristics (f = 1.0 kHz)



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